



### Features

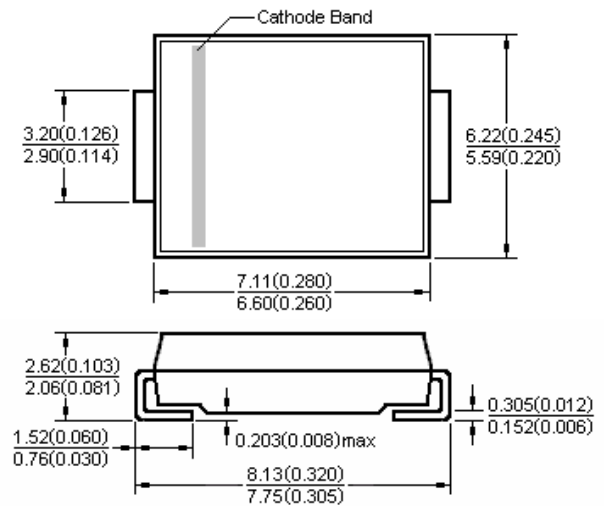
- Glass passivated chip junctions
- Ideal for automated placement
- Ultrafast reverse recovery time for high efficiency
- Low profile package
- High forward surge capability
- High temperature soldering: 260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC

### Mechanical Date

- **Case:** JEDEC DO-214AB molded plastic body over passivated chip
- **Terminals:** Solder plated, solderable per J-STD-002B and JESD22-B102D
- **Polarity:** Laser band denotes cathode end



SMC (DO - 214AB)



Dimensions in millimeters and (inches)

### Maximum Ratings and Electrical Characteristics Rating at 25 °C

ambient temperature unless otherwise specified. Single phase, half wave, 60 Hz, resistive or inductive load. For capacitive load, derate current by 20%

Parameter	Symbols	ES3A	ES3B	ES3C	ES3D	ES3E	ES3G	ES3J	Units	
Maximum Repetitive Peak Reverse Voltage	$V_{RRM}$	50	100	150	200	300	400	600	V	
Maximum RMS voltage	$V_{RMS}$	35	70	105	140	210	280	420	V	
Maximum DC Blocking Voltage	$V_{DC}$	50	100	150	200	300	400	600	V	
Maximum Average Forward Rectified Current at $T_L = 100\text{ }^\circ\text{C}$	$I_{F(AV)}$	3							A	
Peak Forward Surge Current 8.3 ms Single Half Sine Wave Superimposed on Rated Load (JEDEC Method)	$I_{FSM}$	100							A	
Maximum Forward Voltage at 3A	$V_F$	1.0			1.25		1.65		V	
Maximum DC Reverse Current at Rated DC Blocking Voltage $T_a = 25\text{ }^\circ\text{C}$ $T_a = 125\text{ }^\circ\text{C}$	$I_R$	5				100				$\mu\text{A}$
Typical Junction Capacitance	$C_j$	35							pF	
Maximum Reverse Recovery Time at $I_F = 0.5\text{ A}$ , $I_R = 1\text{ A}$ , $I_{rr} = 0.25\text{ A}$	$t_{rr}$	35							ns	
Typical Thermal Resistance <sup>2)</sup>	$R_{\theta JA}$ $R_{\theta JC}$	45				15				$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_j$ , $T_{stg}$	-55 ~ +150							$^\circ\text{C}$	

1) Measured with  $I_F = 0.5\text{ A}$ ,  $I_R = 1\text{ A}$ ,  $I_{rr} = 0.25\text{ A}$

2) P.C.B. mounted with 0.5 X 0.5" (12.7 X 12.7 mm) copper pad areas.



# ES3A-ES3J

## Surface Mount Superfast Rectifiers

### Characteristic Curves ( $T_A=25\text{ }^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

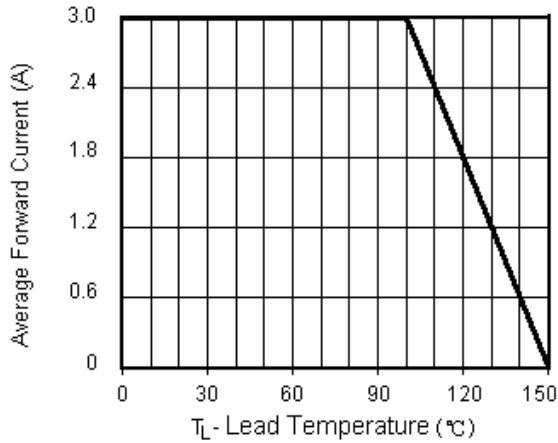


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

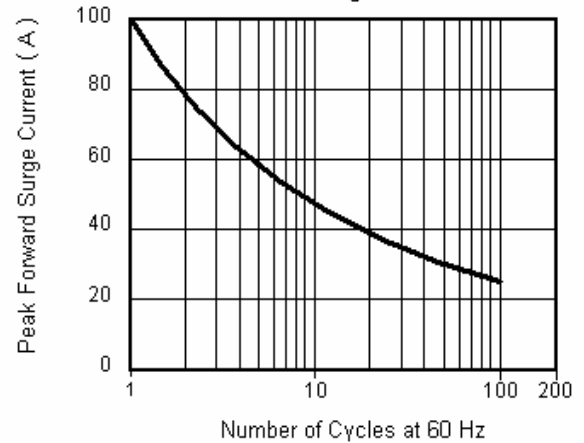


Fig.3 Typical Instantaneous Forward Characteristics

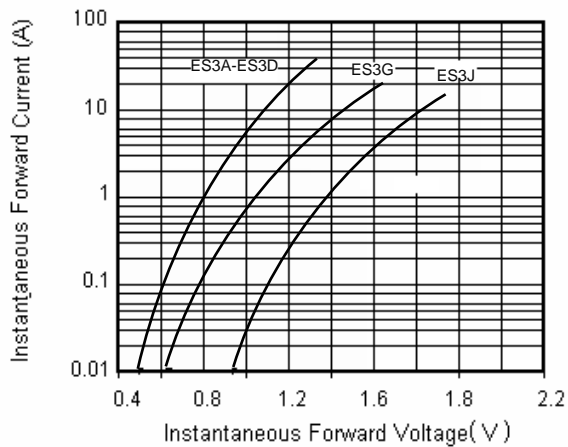


Fig.4 Typical Reverse Leakage Characteristics

